Please indicate receipt of the below-identified paper:
New Application Specification: Pages; Drawings: Sheets
☐ Continuation ☐ Divisional ☐ CIP ☐ CPA
<ul> <li>☑ Response to Office Action dated <u>January 8, 2003</u> Final Rejection</li> <li>☑ Other <u>Amendment, Postcard</u></li> </ul>
☐ Assignment enclosed
Identification of Application:
Serial No. <u>09/901,837</u>
Title LOW TEMPERATURE REFLOW METHOD FOR FILLING
HIGH ASPECT RATIO CONTACTS
Applicant Shubneesh Batra et al.
Client Micron Technology, Inc.
File No. MCRO:1993/FLE (95-0057.03) Attorney Michael G. Fletcher/BLT
Mailed March 7, 2003 Due Date